



DCR1020N52

Phase Control Thyristor

Replaces DS5964-5 DS5964-6 May 2024 (LN43371)

FEATURES

- Double Side Cooling
- High Surge Capability

APPLICATIONS

- Medium Voltage Soft Starts
- High Voltage Power Supplies
- Static Switches

VOLTAGE RATINGS

Part and Ordering Number	Repetitive Peak Voltages VDRM and VRRM (V)	Conditions
DCR1020N52* DCR1020N50	5200 5000	Tvj = -40°C to 125°C, IDRM = IRRM = 100mA, VDRM, VRRM tp = 10ms VDSM & VRSM = VDRM & VRRM + 100V respectively

Lower voltage grades available.

ORDERING INFORMATION

When ordering, select the required part number shown in the Voltage Ratings selection table.

For example:

DCR1020N52

Note: Please use the complete part number when ordering and quote this number in any future correspondence relating to your order.

KEY PARAMETERS

\mathbf{V}_{DRM}	5200V
IT(AV)	1020A
Ітѕм	14800A
dV/dt*	1500V/µs
dl/dt	800A/µs

^{*} Higher dV/dt selections are available on request

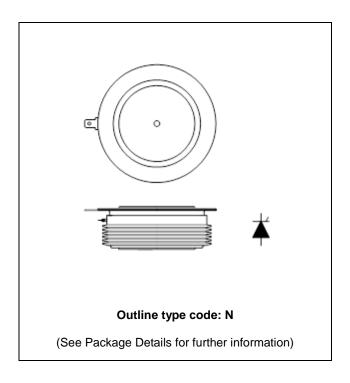


Fig. 1 Package outline

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^{*5000}V @ -40°C, 5200V @ 0°C



CURRENT RATINGS

T_{case} = 60°C unless stated otherwise

Symbol	Parameter	Test Conditions	Max.	Units
Double Side Cooled				
IT(AV)	Mean on-state current	Half wave resistive load	1020	А
IT(RMS)	RMS value	-	1600	А
lτ	Continuous (direct) on-state current	-	1490	А

SURGE RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
Ітѕм	Surge (non-repetitive) on-state current	10ms half sine, Tcase = 125°C	14.8	kA
l²t	I2t for fusing	V _R = 0	1.10	MA ² s

THERMAL AND MECHANICAL RATINGS

Symbol	Parameter	Test Condition	Test Conditions		Max.	Units
1		Double side cooled	DC	-	22.0	°C/kW
Rth(j-c)	Thermal resistance - junction to case		Anode DC	-	40.5	°C/kW
		Single side cooled	Cathode DC	-	50.1	°C/kW
D	The second are interest and the state in large	Clamping force 23kN	Double side	-	4.0	°C/kW
Rth(c-h)	Thermal resistance - case to heatsink	(with mounting compound)	Single side	-	8.0	°C/kW
Tvj	Virtual junction temperature	Blocking VDRM / VRRM		-	125	°C
Tstg	Storage temperature range			-55	125	°C
Fm	Clamping force			20	25	kN

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DYNAMIC CHARACTERISTICS

Symbol	Parameter	Test Condition	ns	Min.	Max.	Units
IRRM/IDRM	Peak reverse and off-state current	At VRRM/VDRM, Tcase = 125°C	;	-	100	mA
V тм	Instantaneous forward voltage	At 2900A peak, Tj = 25°C		2.10	2.30	V
dV/dt	Max. linear rate of rise of off-state voltage	To 67% VDRM, Tj = 125°C, ga	ate open	-	1500	V/µs
dl/dt	Rate of rise of on-state current	From 67% V _{DRM} to 2x I _{T(AV)} Gate source 30V, 10Ω	Repetitive 50Hz	-	200	A/µs
	Nate of fise of off-state current	tr < 0.5µs, Tj = 125°C	Non-repetitive	-	800	A/µs
V	Threshold voltage - Low level	300A to 800A at Tcase = 12	25°C	-	0.92	V
V т(то)	Threshold voltage - High level	800A to 4000A at Tcase = 125°C		-	1.08	٧
_	On-state slope resistance - Low level	300A to 800A at Tcase = 125°C		-	0.79	mΩ
ľτ	On-state slope resistance - High level	800A to 4000A at Tcase = 12	00A at Tcase = 125°C		0.60	mΩ
t gd	Delay time	V_D = 67% V_{DRM} , gate source 30V, 10Ω t_T = 0.5 μ s, T_j = 25°C		-	3	μs
tq	Turn-off time	Tj = 125°C, Ipeak = 1000A, tp = 1000μs, VRM = 100V, dI/dt = 5A/μs, dVDR/dt = 20V/μs linear to 2000V		-	1000	μs
Qs	Stored charge	Iτ = 1000A, tp = 1000μs, Tj =	= 125°C,	2200	3800	μC
IRR	Reverse recovery current	dl/dt = 5A/μs, VR peak = 100V. [LEM]		90	115	А
Qs	Stored charge	T _j = 125°C, dl/dt = 1A/μs,		(Typ.) 1680		μC
IRR	Reverse recovery current	VR peak ~ 3000V, VR ~ 2200V		(Тур).) 33	А
I L	Latching current	Tj = 25°C, VD = 5V		-	3	А
Ін	Holding current	$T_j = 25^{\circ}C, R_{G-K} = \infty, I_{TM} = 50$	0A, IT = 5A	1	300	mA

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GATE TRIGGER CHARACTERISTICS AND RATINGS

Symbol	Parameter	Test Conditions	Max.	Units
V GT	Gate trigger voltage	VDRM = 5V, Tcase = 25°C	1.5	V
V _{GD}	Gate non-trigger voltage	At 50% VDRM, Tcase = 125°C	0.4	V
lgт	Gate trigger current	VDRM = 5V, Tcase = 25°C	350	mA
IGD	Gate non-trigger current	At 50% VDRM, Tcase = 125°C	15	mA

CURVES

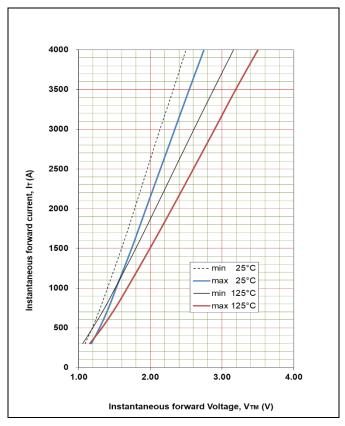


Fig. 2 Maximum & minimum on state characteristics

VTM EQUATION

 $V_{TM} = A + B.ln(I_T) + C.I_T + D.\sqrt{I_T}$

Where A = -0.070068

B = 0.224191

C = 0.000656

D = -0.014462

These values are valid for $T_j = 125^{\circ}C$ for I_{T} 300A to 4000A

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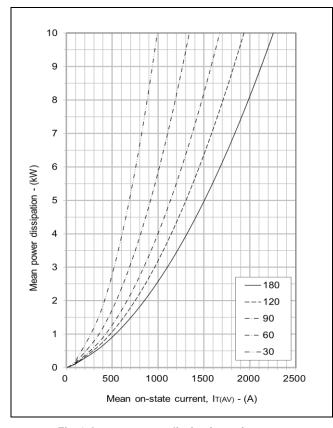


Fig. 3 On-state power dissipation - sine wave

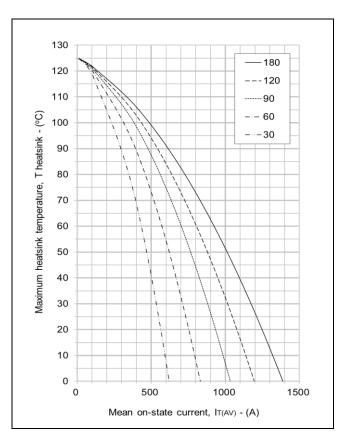


Fig. 5 Maximum permissible heatsink temperature, double side cooled - sine wave

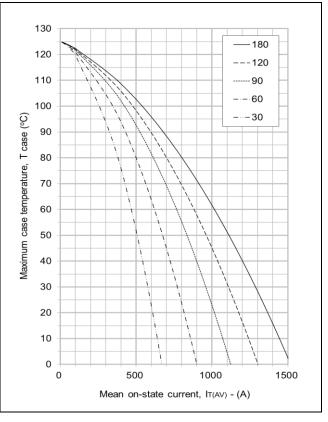


Fig. 4 Maximum permissible case temperature, double side cooled - sine wave

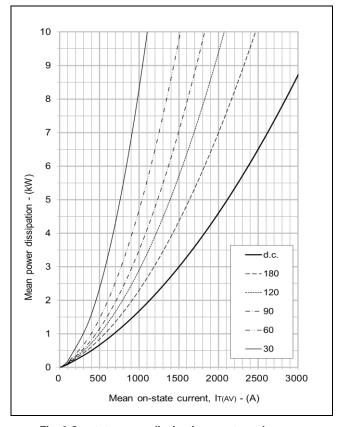


Fig. 6 On-state power dissipation - rectangular wave

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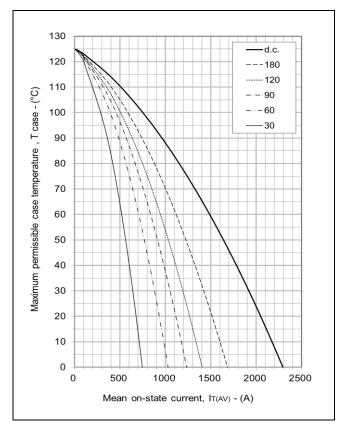
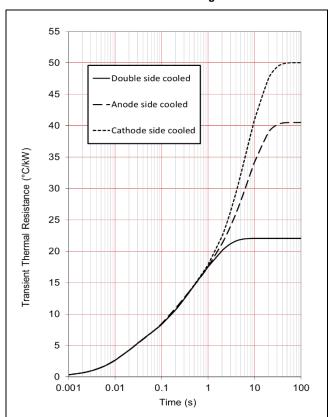


Fig. 7 Maximum permissible case temperature, double side cooled - rectangular wave



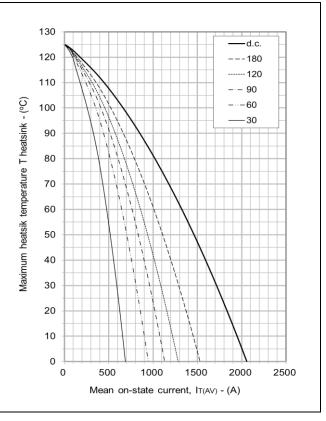


Fig. 8 Maximum permissible heatsink temperature, double side cooled - rectangular wave

		1	2	3	4
Double side	Ri(°C/kW)	3.473	4.905	9.146	4.522
cooled	Ti(s)	0.146	0.017	1.283	0.377
Anode side	Ri(°C/kW)	6.039	4.278	5.130	25.087
cooled	Ti(s)	0.136	0.014	0.659	7.236
Cathode side	Ri(°C/kW)	7.667	5.053	9.736	27.599
cooled	Ti(s)	0.224	0.017	4.057	8.278

$$Z_{th} = \sum_{i=1}^{i=4} R_i \cdot \left(1 - \exp\left(-\frac{T}{T_i}\right)\right)$$

 $\Delta R_{\text{th(j-c)}}$ Conduction

Tables show the increments of thermal resistance R $_{\text{th}[j-c]}$ when the device operates at conduction angles other than d.c.

	Double side cooling				
	$\Delta Z_{th}(z)$				
θ°	sine.	rect.			
180	3.03	2.07			
120	3.49	2.95			
90	3.99	3.43			
60	4.43	3.94			
30	4.77	4.49			
15	4 92	4 77			

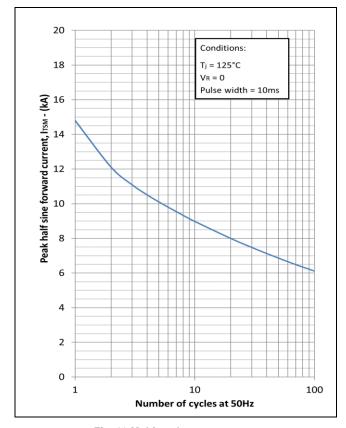
COUNTY			Arrode Side Coolling				
Z _{th} (Z _{th} (Z)			ΔZ_t	h (Z)		
	rect.		θ°	sine.	rect.		
	2.07		180	3.03	2.07		
	2.95		120	3.49	2.95		
	3.43		90	3.99	3.43		
	3.94		60	4.43	3.94		
	4.49		30	4.76	4.48		
	4.77	1	15	4.02	4.77		

Cathode Sided Cooling				
	ΔZ_{th} (z)			
θ°	sine.	rect.		
180	3.12	2.12		
120	3.61	3.04		
90	4.13	3.54		
60	4.60	4.08		
30	4.96	4.66		
15	5.13	4 07		

Fig. 9 Maximum (limit) transient thermal impedance - junction to case (degC/kW)

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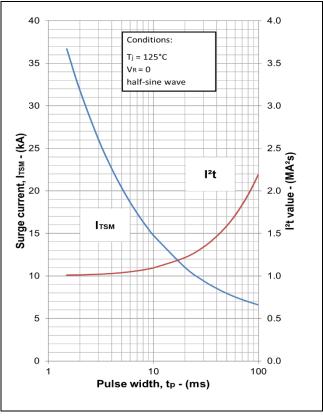


Fig. 10 Multi-cycle surge current

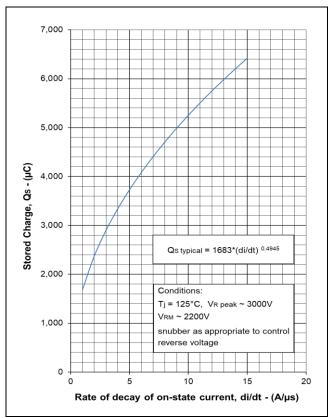


Fig. 12 Stored charge

Fig. 11 Single-cycle surge current

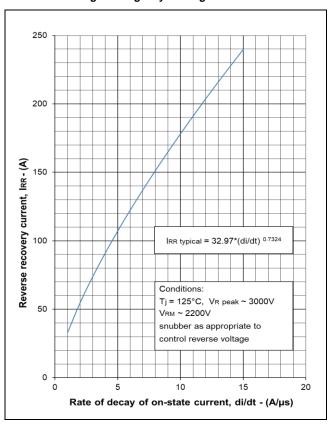


Fig. 13 Reverse recovery current

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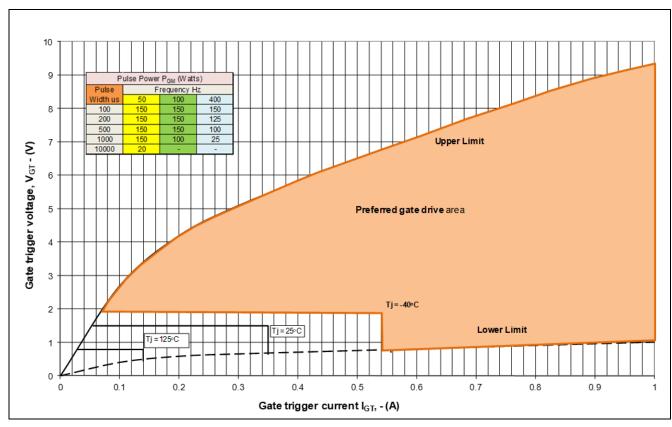


Fig. 14 Gate characteristics

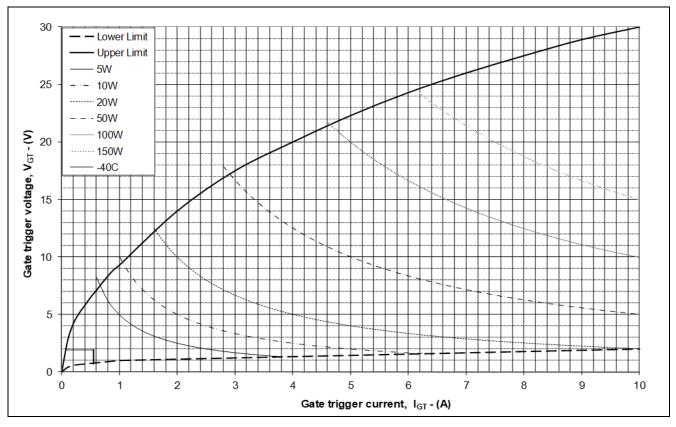


Fig. 15 Gate characteristics

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PACKAGE DETAILS

For further package information, please contact Customer services.

All dimensions in mm, unless stated otherwise.

DO NOT SCALE

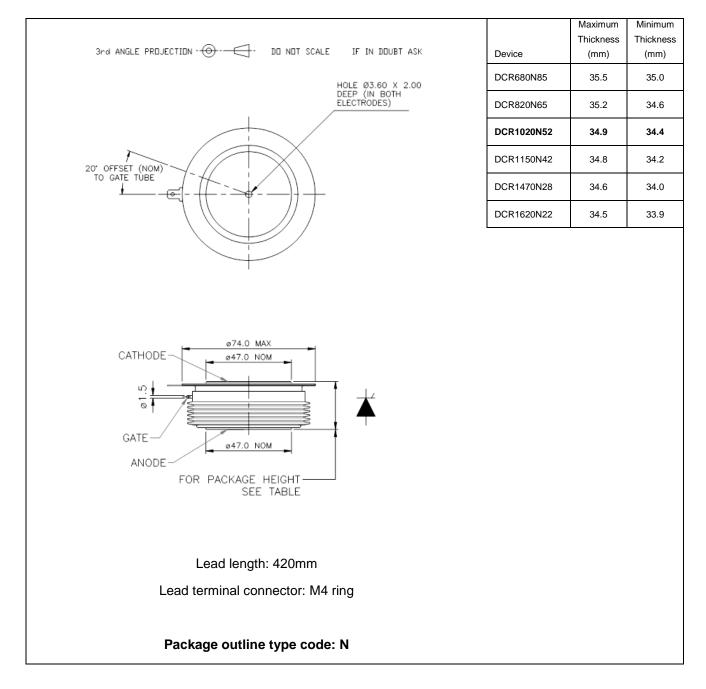


Fig. 16 Package outline

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HEADQUARTERS OPERATIONS

DYNEX SEMICONDUCTOR LIMITED Doddington Road, Lincoln, Lincolnshire. LN6 3LF

United Kingdom.

Phone: +44 (0) 1522 500500

Web: http://www.dynexsemi.com

CUSTOMER SERVICE

Phone: +44 (0) 1522 502753 / 502901

e-mail: powersolutions@dynexsemi.com

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